PRODUCT SPECIFICATION



3.4" TFT LCD MODULE MODEL: YDP LCD I 340 R

< >> Preliminary Specification

< ◆> Finally Specification

	CUSTOMER'S APPROVAL							
CUSTOMER:	CUSTOMER:							
SIGNATURE: DATE:								

APPROVED	PM	PD	PREPARED
ВҮ	REVIEWED	REVIEWED	BY
TFT			TFT
(S. G. H)			(L. Q)
20220621			20220621

knitter-switch

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2022.06.21	LQ	Initial Release	

Table of Contents

No. Item	Page
1. General Description	4
2. Module Parameter	4
3. Absolute Maximum Ratings	4
4. DC Characteristics	5
5. Backlight Characteristic	5
5.1. Backlight Characteristics	5
5.2. Backlighting circuit	5
6. Optical Characteristics	6
6.1. Optical Characteristics	6
6.2. Definition of Response Time	6
6.3. Definition of Contrast Ratio	7
6.4. Definition of Viewing Angles	7
6.5. Definition of Color Appearance	8
6.6. Definition of Surface Luminance, Uniformity and Transmittance	8
7. Block Diagram and Power Supply	9
8. Interface Pins Definition	10
9. AC Characteristics	11
9.1. RGB Interface Characteristics	11
9.2. Power ON/OFF Sequence	12
10. Quality Assurance	13
10.1. Purpose	13
10.2. Standard for Quality Test	13
10.3. Nonconforming Analysis & Disposition	13
10.4. Agreement Items	13
10.5. Standard of the Product Visual Inspection	13
10.6. Inspection Specification	14
10.7. Classification of Defects	18
10.8. Identification/marking criteria	18
10.9. Packing	18
11. Reliability Specification	19
12. Precautions and Warranty	20
12.1. Safety	20
12.2. Handling	20
12.3. Storage	20
12.4. Metal Pin (Apply to Products with Metal Pins)	20
12.5. Operation	21
12.6. Static Electricity	21
12.7. Limited Warranty	21
13. Packaging	22
14. Outline Drawing	23

1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	3.4"	
LCD type	IPS TFT	
Display Mode	Transmissive /Normally Black	
Resolution	412 RGB x 960	Pixels
View Direction	Full viewing	Best Image
Module Outline	38.135(H) x 87.82(V) x 2.55(T) (Note1)	mm
Active Area	33.99(H) x 79.2(V)	mm
Pixel Size	82.5(H) x 82.5(V)	um
Pixel Arrangement	RGB Vertical stripe	
Display Colors	16.7M	
Interface	24-Bit RGB	
Driver IC	ST7701S	-
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	TBD	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

GND=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VDD	-0.3	4.6	V
Storage temperature	Tstg	-30	+80	°C
Operating temperature	Тор	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Analog Operating voltage	VDD	2.5	2.8	3.3	V
Logic Low input voltage	V_{IL}	GND	-	0.3*VDD	V
Logic High input voltage	V_{IH}	0.7*VDD	-	VDD	V
Logic Low output voltage	V _{OL}	GND	-	0.2*VDD	V
Logic High output voltage	V _{OH}	0.8*VDD	-	VDD	V
Current Consumption All White	I_{VDD}	-	TBD	-	mA

5. Backlight Characteristic

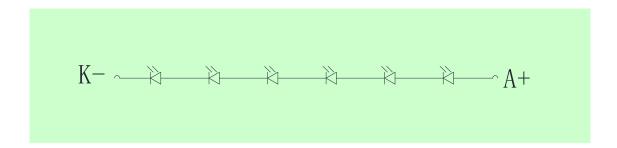
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, IF=20mA/LED	17.4	19.2	20.4	V
Forward Current	lF	Ta=25 °C, VF=3.2V/LED	-	20	-	mA
Power dissipation	Pd		-	384	-	mW
Uniformity	Avg		80	-	-	%
LED working life(25°C)	-		-	30000	-	Hrs
Drive method	Constant current					
LED Configuration		6 White LEDs (6	LEDs in	string)		·

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25 ±2 °C,60%RH ±5 %, I_F=20mA/LED.

5.2. Backlighting circuit



6. Optical Characteristics

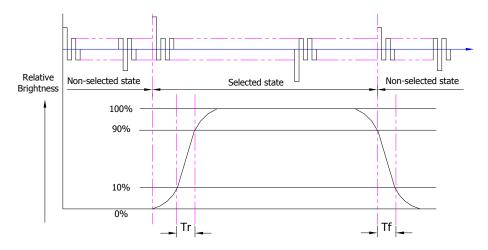
6.1. Optical Characteristics

Ta=25°C, VDD=2.8V

	Itei	—	Symbol	Condition	S	pecificati	on	Unit	
	itei	11	Symbol	Condition	Min.	Тур.	Max.	Unit	
	Luminance on								
	TFT(I_f =20)mA/LED)	Lv	Normally	248	310	-	cd/m²	
👸	Contrast rati	o(See 6.3)	CR	viewing angle	-	1000	-		
Backlight On (Transmissive Mode)	Response time (See 6.2)		TR+TF	$\theta x = \phi Y = 0^{\circ}$	-	30	35	ms	
nis		Red			-	TBD	-		
nsr			Reu	YR		-	TBD	-	
Tra	Changan eti eitu	Green	X G		-	TBD	-		
ر ا	Chromaticity Transmissive	Gieen	Yg		-	TBD	ı		
=	(See 6.5)	Blue	Хв		1	TBD	1		
	(366 0.3)	blue	YΒ		-	TBD	1		
ac <mark>k</mark>		White	Xw		ı	TBD	ı		
B		vviile	Yw		-	TBD	-		
) (in the second		θх+		-	85	-		
	Angle	Horizontal	θх-	Center CR≥10	-	85	-	Deg.	
		Vertical	φY+		-	85	-	Deg.	
	(See 6.4) Vertical		φY-		-	85	-		
	NTSC Ratio	o(Gamut)			50	60	-	%	

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)



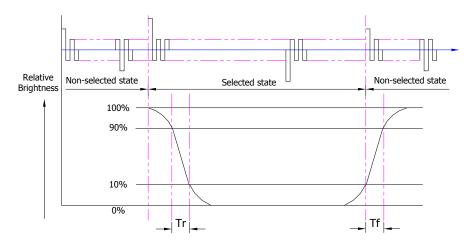
Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to

non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

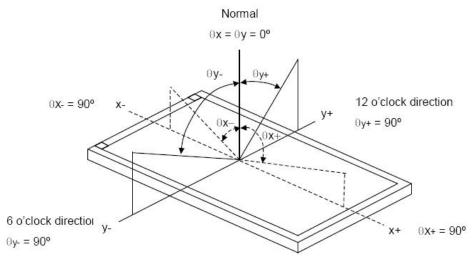
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Toot nottorn	A: All Pixels white
Test pattern	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles

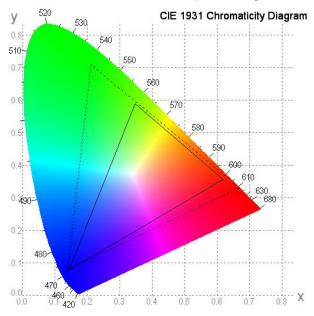


Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

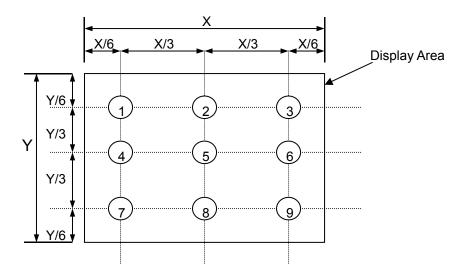


6.6. Definition of Surface Luminance, Uniformity and Transmittance

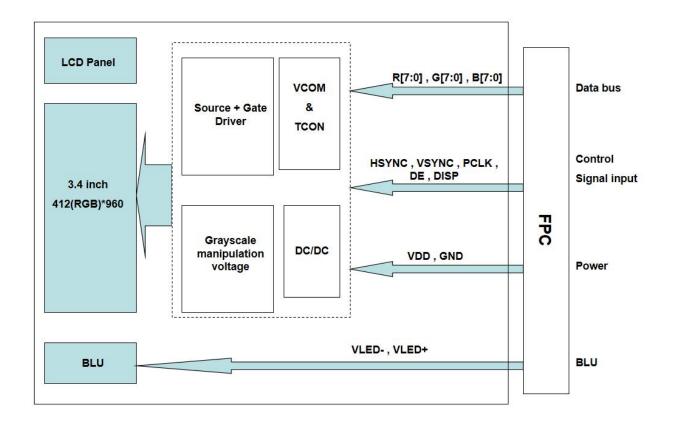
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 6.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply

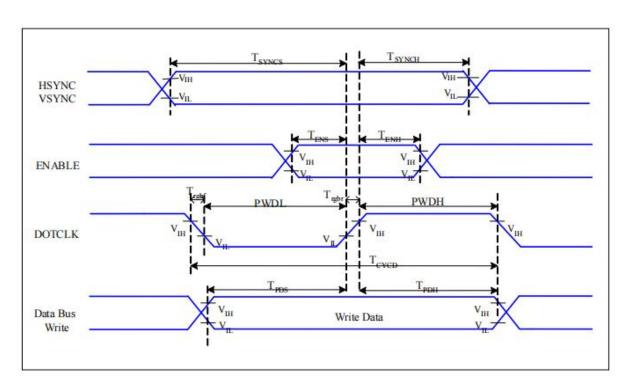


8. Interface Pins Definition

No.	Symbol	Function
1	VLED-	Backlight Cathode
2	VLED+	Backlight Anode
3	GND	Ground
4	VDD	Power source
5	R0	Red data signal
6	R1	Red data signal
7	R2	Red data signal
8	R3	Red data signal
9	R4	Red data signal
10	R5	Red data signal
11	R6	Red data signal
12	R7	Red data signal
13	G0	Green data signal
14	G1	Green data signal
15	G2	Green data signal
16	G3	Green data signal
17	G4	Green data signal
18	G5	Green data signal
19	G6	Green data signal
20	G7	Green data signal
21	B0	Blue data signal
22	B1	Blue data signal
23	B2	Blue data signal
24	B3	Blue data signal
25	B4	Blue data signal
26	B5	Blue data signal
27	B6	Blue data signal
28	B7	Blue data signal
29	GND	Ground
30	PCLK	Clock signal to sample each data
31	DISP	Display on/off signal,DISP="H" Display on,DISP="L" Display off
32	HSYNC	Horizontal synchronizing signal
33	VSYNC	Vertical synchronizing signal
34	DE	Input data enable control
35	NC	No connection
36	GND	Ground
37	NC	No connection
38	NC	No connection
39	NC	No connection
40	NC	No connection

9. AC Characteristics

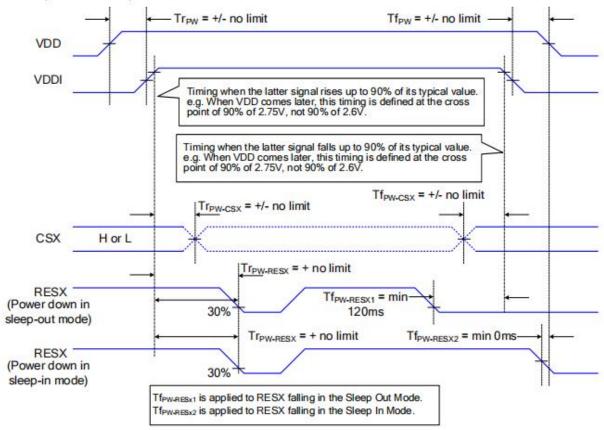
9.1. RGB Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description		
HSYNC, VSYNC	Tsyncs	SYNCS VSYNC, HSYNC Setup Time		T _{SYNCS} VSYNC, HSYNC Setup Time 5		a	ns	
ENABLE	TENS	Enable Setup Time	5		ns			
ENABLE	T _{ENH}	Enable Hold Time	5	я	ns			
	PWDH	DOTCLK High-level Pulse Width	15	-	ns			
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	15	7	ns			
DOTCER	Тсуср	DOTCLK Cycle Time	33		ns			
	Trghr, Trghf	DOTCLK Rise/Fall time	-	15	ns			
-	TPDS	PD Data Setup Time	5		ns			
DB	T _{PDH}	PD Data Hold Time	5		ns			

9.2. Power ON/OFF Sequence





Notes:

- 1. There will be no damage to the ST7701S if the power sequences are not met.
- 2. There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
- 3. There will be no abnormal visible effects on the display between the end of Power On Sequence and before receiving the Sleep Out command, and also between receiving the Sleep In command and the Power Off Sequence.
- 4. If the RESX line is not steadily held by the host during the Power On Sequence as defined in Sections 9.1, then it will be necessary to apply the Hardware Reset (RESX) after the completion of the Host Power On Sequence to ensure correct operations. Otherwise, all the functions are not guaranteed.
- 5. When VDDA is in power off State, the MIPI must set in Ultra Low Power Mode (GND Level).

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2. Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5.

Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3. Nonconforming Analysis & Disposition

- 10.3.1. Nonconforming analysis:
 - 10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.
 - 10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.
- 10.3.2. Disposition of nonconforming:
 - 10.3.2.1. Non-conforming product over PPM level will be replaced.
 - 10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4. Agreement Items

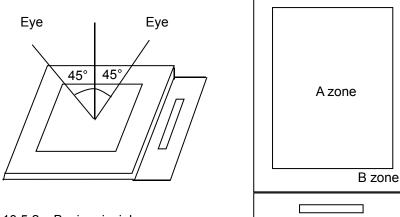
Shall negotiate with customer if the following situation occurs:

- 10.4.1. There is any discrepancy in standard of quality assurance.
- 10.4.2. Additional requirement to be added in product specification.
- 10.4.3. Any other special problem.

10.5. Standard of the Product Visual Inspection

- 10.5.1. Appearance inspection:
 - 10.5.1.1. The inspection must be under illumination about $1000 1500 \, lx$, and the distance of view must be at $30 \, cm \pm 2 \, cm$.
 - 10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,



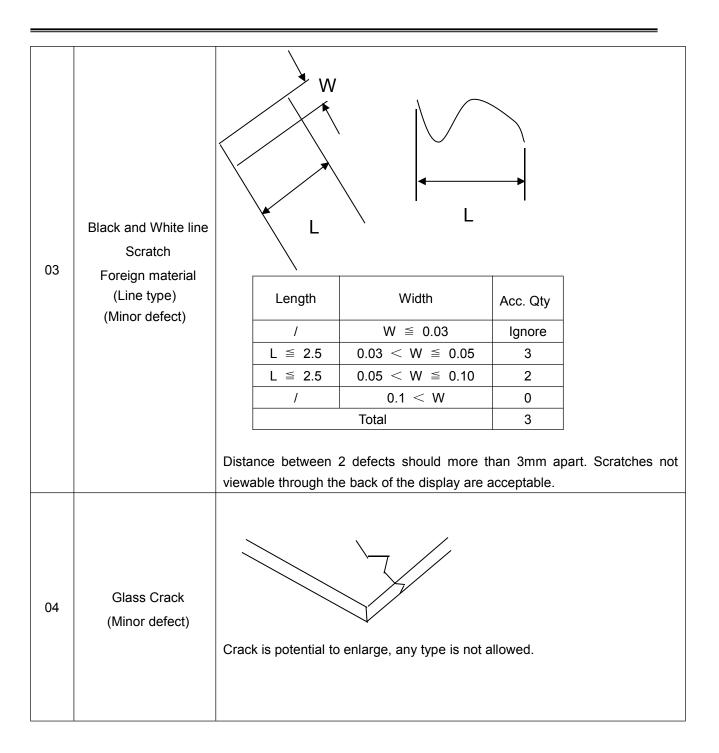
10.5.2. Basic principle:

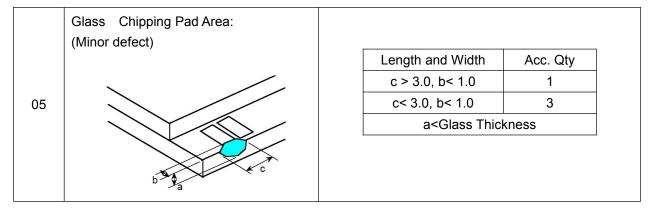
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

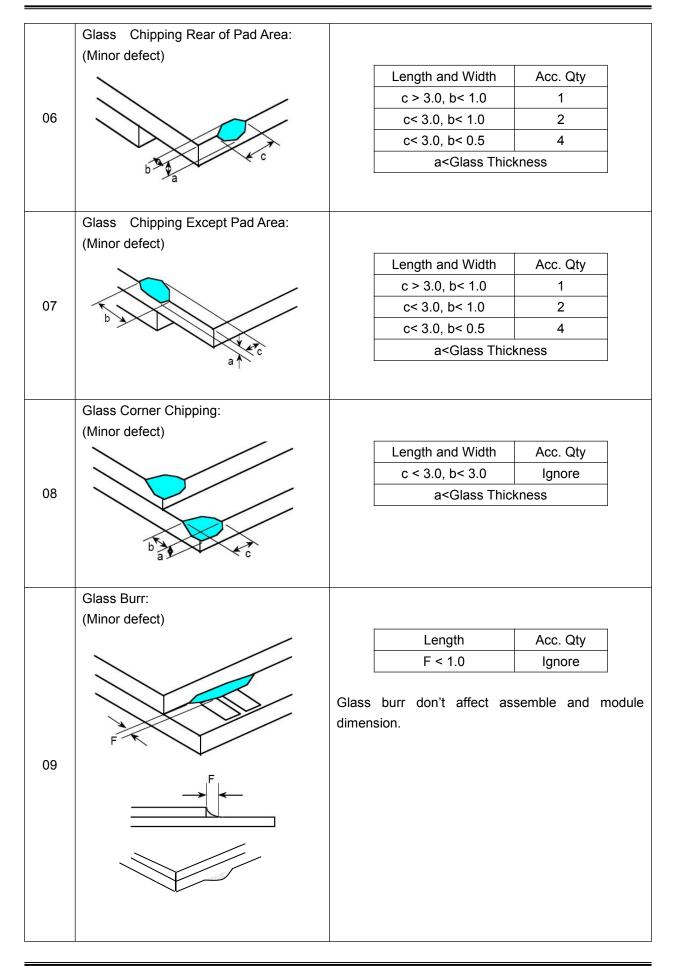
10.5.2.2. New item must be added on time when it is necessary.

10.6.Inspection Specification

No.	Item	Criteria (Unit: mm)			
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	φ= (a + b) /2 Distance between 2 defects show	Area Size φ≤0.10 0.10<φ≤0.15 0.15<φ≤0.25 0.25<φ Total	Acc. Qty Ignore 2 1 0 2 no include φ≤ 0.10	
02	Electrical Defect (Minor defect)	Display Art Bright dot 0 Dark dot N≤2 Total dot N≤2 Mura Not visible Remark: 1. Bright dot caused by scratch	0 N≤2 N≤2 through 5% ND filters.		







	I				
10	FPC Defect: (Minor defect)	-	10.1 Dent, pinhole v (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, o	unacceptable.	nd distortion.
11	Bubble on Polarizer (Minor defect)		Diameter φ≤0.20 0.20 <φ≤0.30 0.30 <φ≤0.50 0.50 < φ	Acc. Qty Ignore 4 1 None	
12	Dent on Polarizer (Minor defect)		Diameter φ≤0.20 0.20 <φ≤0.30 0.30 <φ≤0.50 0.50 < φ	Acc. Qty Ignore 4 1 None	
13	Bezel	13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.			
14	РСВ	 14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F. 			
15	Soldering	Follow IPC-A-610C standard			
16	Electrical Defect (Major defect)	The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function.			

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

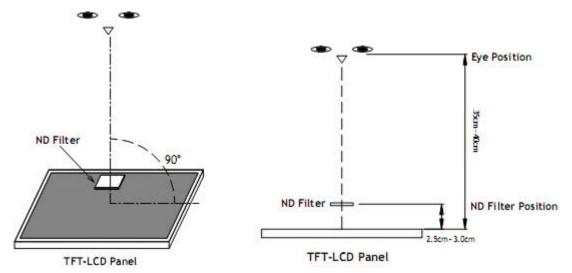
10.8.Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9. Packing

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity Storage	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2016
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test Storage	-20℃, 60min~70℃, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: \pm 4KV 150pF/330 Ω 5 times	2	GB/T17626.2 -2018
		Contact: \pm 2KV 150pF/330 Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value.

12. Precautions and Warranty

12.1.Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

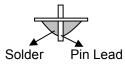
Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

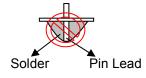
Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



Recommended



Not Recommended

12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

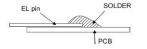
Typical Soldering Time: ≤2s

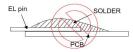
Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

12.4.2.6. Solder Wetting





Recommended

Not Recommended

12.4.2.7. The type of the solder iron:





Recommended

Not Recommended

12.4.2.8. Solder Pad



12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it will develop image sticking due to the TFT structure.

12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

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TBD

14. Outline Drawing

